

# ANTREX Electronics

## Electronic Components Sourcing Information

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### Product Reference Information

|                      |                           |
|----------------------|---------------------------|
| <b>Part Number:</b>  | SUP90N06-6M0P-E3          |
| <b>Manufacturer:</b> | Vishay Siliconix          |
| <b>Package:</b>      | Please confirm with sales |
| <b>Availability:</b> | Please confirm with sales |

**Product Page:**

<https://antrexco.com/product/details/vishay-siliconix/sup90n06-6m0p-e3.html>

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### Contact Information

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New & Original Components

Supplier verification and packaging condition review

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Secure sourcing support for OEM / EMS projects

**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

## N-Channel 60-V (D-S) MOSFET

### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A)       | $Q_g$ (Typ.) |
|--------------|---------------------------|-----------------|--------------|
| 60           | 0.006 at $V_{GS} = 10$ V  | 90 <sup>d</sup> | 78.5         |

### FEATURES

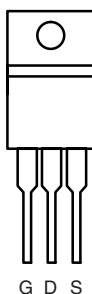
- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 %  $R_g$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



### APPLICATIONS

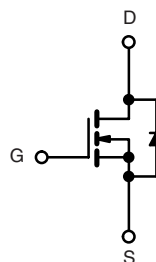
- Power Supply
  - Secondary Synchronous Rectification
- Industrial

TO-220AB



Top View

Ordering Information: SUP90N06-6m0P-E3 (Lead (Pb)-free)



N-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

| Parameter                                        | Symbol         | Limit            | Unit |
|--------------------------------------------------|----------------|------------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | 60               | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$         |      |
| Continuous Drain Current ( $T_J = 175$ °C)       | $I_D$          | 90 <sup>d</sup>  | A    |
|                                                  |                | 90 <sup>d</sup>  |      |
| Pulsed Drain Current                             | $I_{DM}$       | 240              |      |
| Avalanche Current                                | $I_{AS}$       | 50               |      |
| Single Avalanche Energy <sup>a</sup>             | $E_{AS}$       | 125              | mJ   |
| Maximum Power Dissipation <sup>a</sup>           | $P_D$          | 272 <sup>b</sup> | W    |
|                                                  |                | 3.75             |      |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | - 55 to 175      | °C   |

### THERMAL RESISTANCE RATINGS

| Parameter                                    | Symbol     | Limit | Unit |
|----------------------------------------------|------------|-------|------|
| Junction-to-Ambient (PCB Mount) <sup>c</sup> | $R_{thJA}$ | 40    | °C/W |
| Junction-to-Case (Drain)                     | $R_{thJC}$ | 0.55  |      |

Notes:

a. Duty cycle  $\leq 1$  %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

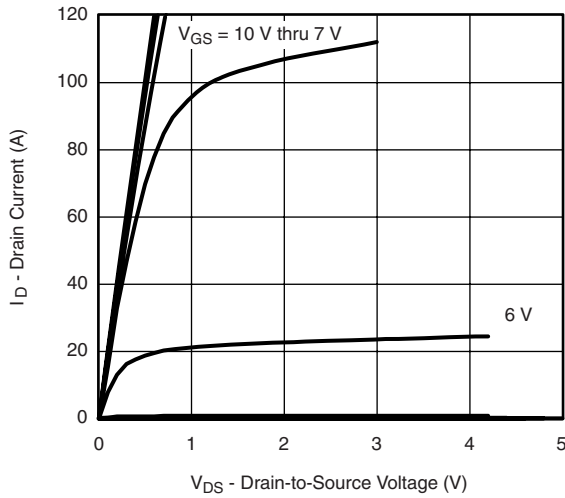
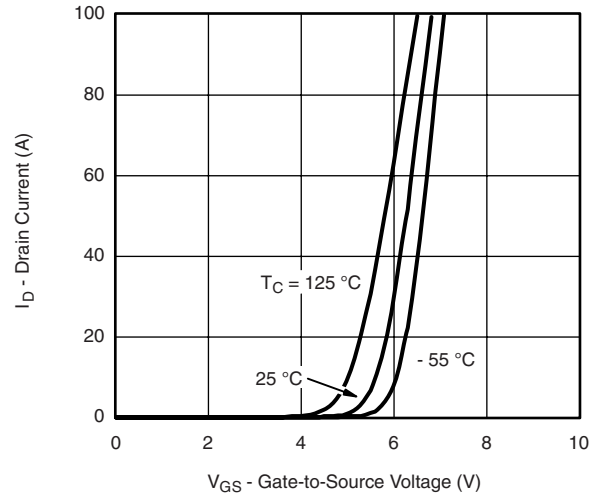
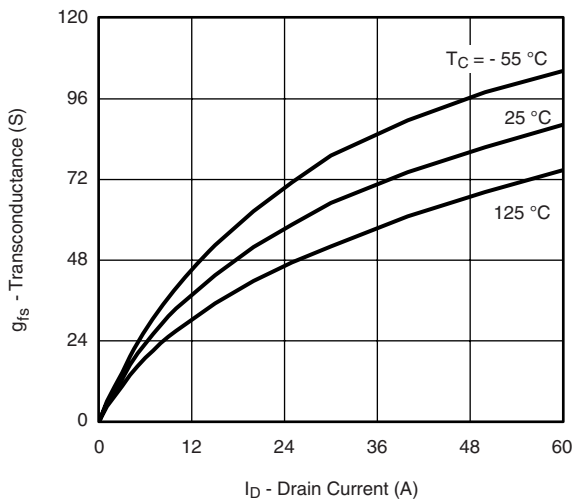
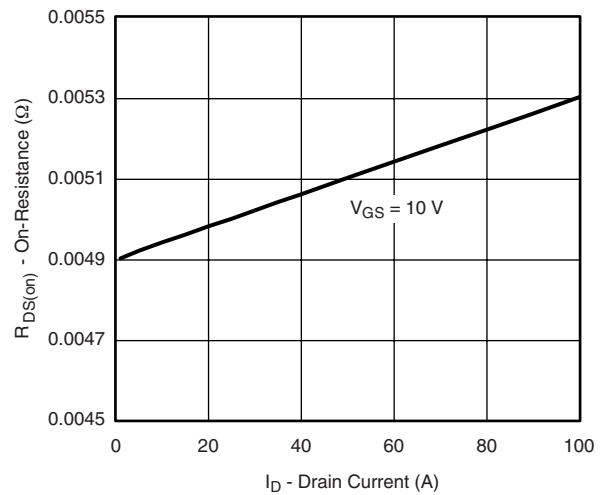
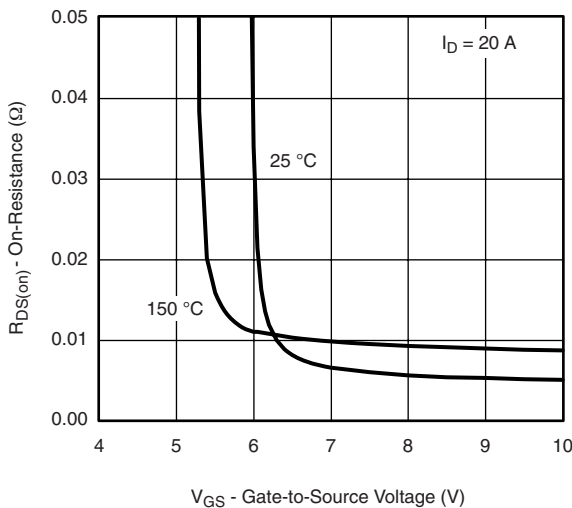
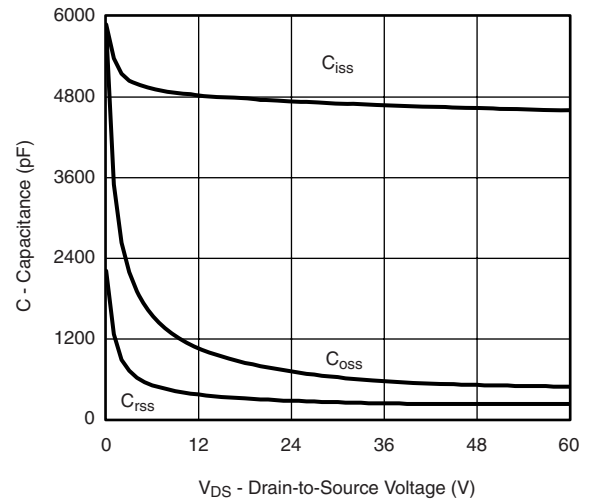
d. Package limited.

| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted                     |               |                                                                                                                                   |      |       |           |               |
|------------------------------------------------------------------------------------------------|---------------|-----------------------------------------------------------------------------------------------------------------------------------|------|-------|-----------|---------------|
| Parameter                                                                                      | Symbol        | Test Conditions                                                                                                                   | Min. | Typ.  | Max.      | Unit          |
| Static                                                                                         |               |                                                                                                                                   |      |       |           |               |
| Drain-Source Breakdown Voltage                                                                 | $V_{DS}$      | $V_{DS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                            | 60   |       |           | V             |
| Gate Threshold Voltage                                                                         | $V_{GS(th)}$  | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                | 2.5  |       | 4.5       |               |
| Gate-Body Leakage                                                                              | $I_{GSS}$     | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                                                                |      |       | $\pm 250$ | nA            |
| Zero Gate Voltage Drain Current                                                                | $I_{DSS}$     | $V_{DS} = 60\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                    |      |       | 1         | $\mu\text{A}$ |
|                                                                                                |               | $V_{DS} = 60\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                              |      |       | 50        |               |
|                                                                                                |               | $V_{DS} = 60\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                                              |      |       | 250       |               |
| On-State Drain Current <sup>a</sup>                                                            | $I_{D(on)}$   | $V_{DS} \geq 10\text{ V}$ , $V_{GS} = 10\text{ V}$                                                                                | 70   |       |           | A             |
| Drain-Source On-State Resistance <sup>a</sup>                                                  | $R_{DS(on)}$  | $V_{GS} = 10\text{ V}$ , $I_D = 20\text{ A}$                                                                                      |      | 0.005 | 0.006     | $\Omega$      |
|                                                                                                |               | $V_{GS} = 10\text{ V}$ , $I_D = 20\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                |      | 0.008 | 0.010     |               |
| Forward Transconductance <sup>a</sup>                                                          | $g_{fs}$      | $V_{DS} = 15\text{ V}$ , $I_D = 20\text{ A}$                                                                                      |      | 58    |           | S             |
| Dynamic <sup>b</sup>                                                                           |               |                                                                                                                                   |      |       |           |               |
| Input Capacitance                                                                              | $C_{iss}$     | $V_{GS} = 0\text{ V}$ , $V_{DS} = 30\text{ V}$ , $f = 1\text{ MHz}$                                                               |      | 4700  |           | pF            |
| Output Capacitance                                                                             | $C_{oss}$     |                                                                                                                                   |      | 620   |           |               |
| Reverse Transfer Capacitance                                                                   | $C_{rss}$     |                                                                                                                                   |      | 250   |           |               |
| Total Gate Charge <sup>c</sup>                                                                 | $Q_g$         | $V_{DS} = 30\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 50\text{ A}$                                                             |      | 78.5  | 120       | nC            |
| Gate-Source Charge <sup>c</sup>                                                                | $Q_{gs}$      |                                                                                                                                   |      | 28    |           |               |
| Gate-Drain Charge <sup>c</sup>                                                                 | $Q_{gd}$      |                                                                                                                                   |      | 20.6  |           |               |
| Gate Resistance                                                                                | $R_g$         | $f = 1\text{ MHz}$                                                                                                                |      | 1.2   | 2.4       | $\Omega$      |
| Turn-On Delay Time <sup>c</sup>                                                                | $t_{d(on)}$   | $V_{DD} = 30\text{ V}$ , $R_L = 0.6\text{ }\Omega$<br>$I_D \cong 50\text{ A}$ , $V_{GEN} = 10\text{ V}$ , $R_g = 1\text{ }\Omega$ |      | 16    | 30        | ns            |
| Rise Time <sup>c</sup>                                                                         | $t_r$         |                                                                                                                                   |      | 10    | 20        |               |
| Turn-Off Delay Time <sup>c</sup>                                                               | $t_{d(off)}$  |                                                                                                                                   |      | 25    | 40        |               |
| Fall Time <sup>c</sup>                                                                         | $t_f$         |                                                                                                                                   |      | 8     | 15        |               |
| Source-Drain Diode Ratings and Characteristics $T_C = 25\text{ }^{\circ}\text{C}$ <sup>b</sup> |               |                                                                                                                                   |      |       |           |               |
| Continuous Current                                                                             | $I_S$         |                                                                                                                                   |      |       | 85        | A             |
| Pulsed Current                                                                                 | $I_{SM}$      |                                                                                                                                   |      |       | 240       |               |
| Forward Voltage <sup>a</sup>                                                                   | $V_{SD}$      | $I_F = 20\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                       |      | 0.83  | 1.5       | V             |
| Reverse Recovery Time                                                                          | $t_{rr}$      | $I_F = 75\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$                                                                          |      | 62    | 100       | ns            |
| Peak Reverse Recovery Current                                                                  | $I_{RM(REC)}$ |                                                                                                                                   |      | 3.8   | 5.7       | A             |
| Reverse Recovery Charge                                                                        | $Q_{rr}$      |                                                                                                                                   |      | 118   | 180       | nC            |

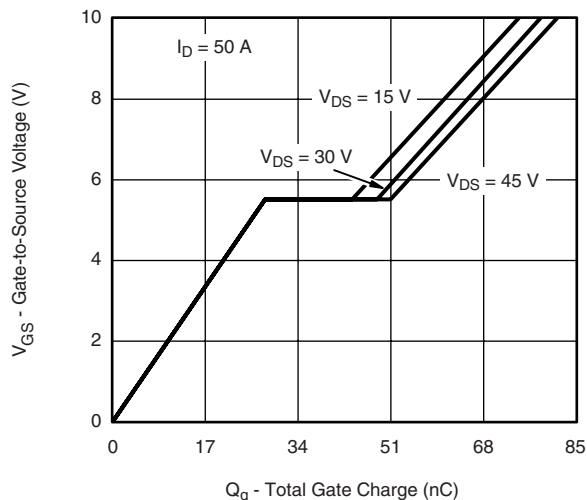
## Notes:

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.  
c. Independent of operating temperature.

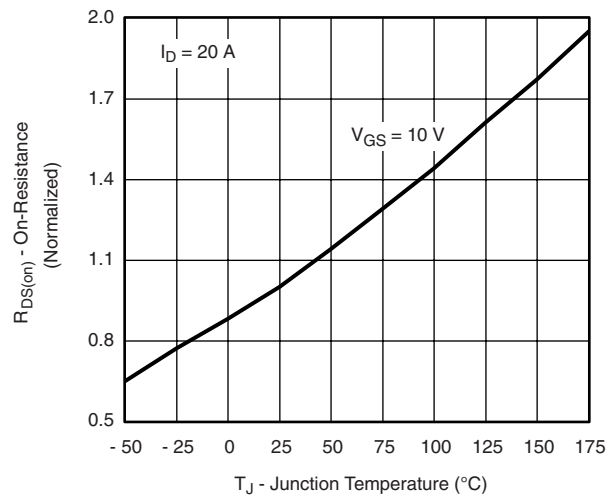
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Output Characteristics**

**Transfer Characteristics**

**Transconductance**

**On-Resistance vs. Drain Current**

**On-Resistance vs. Gate-to-Source Voltage**

**Capacitance**

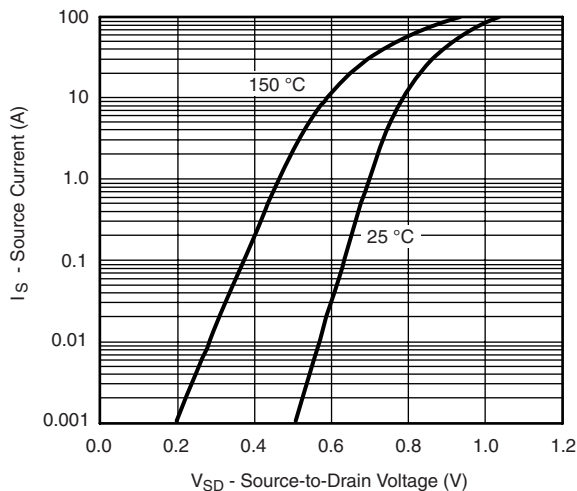
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



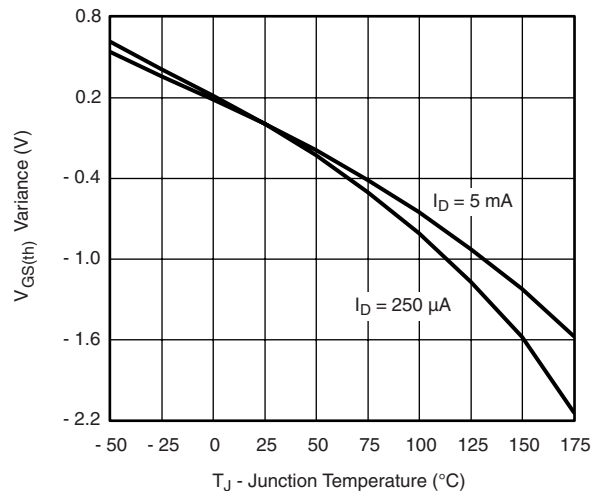
On-Resistance vs. Junction Temperature



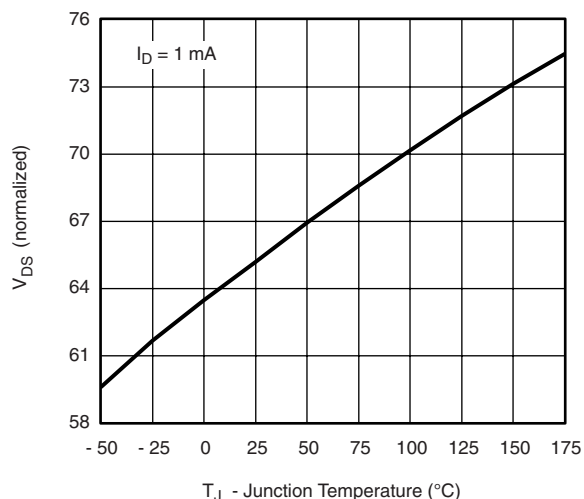
Threshold Voltage



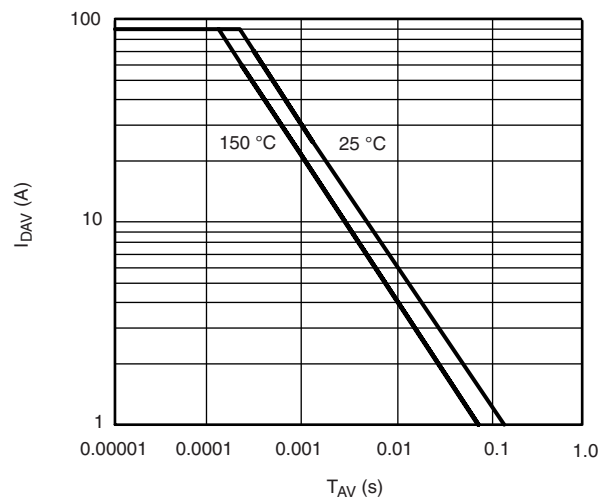
Gate Charge



On-Resistance vs. Junction Temperature

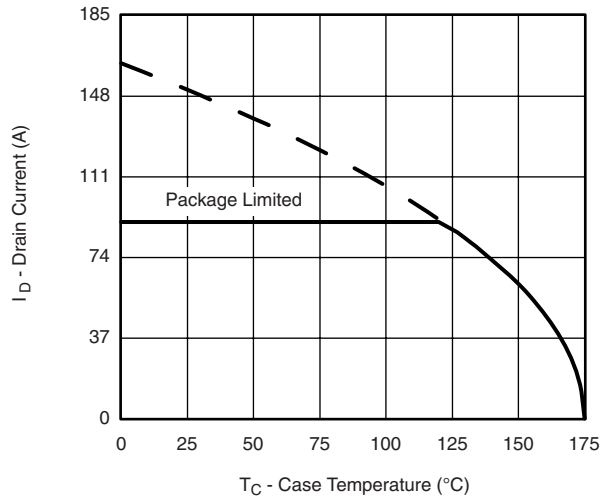


Source-Drain Diode Forward Voltage

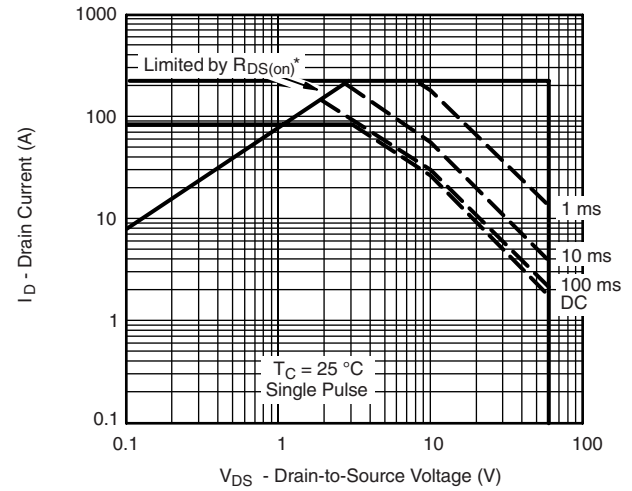


Maximum Drain Current vs. Case Temperature

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

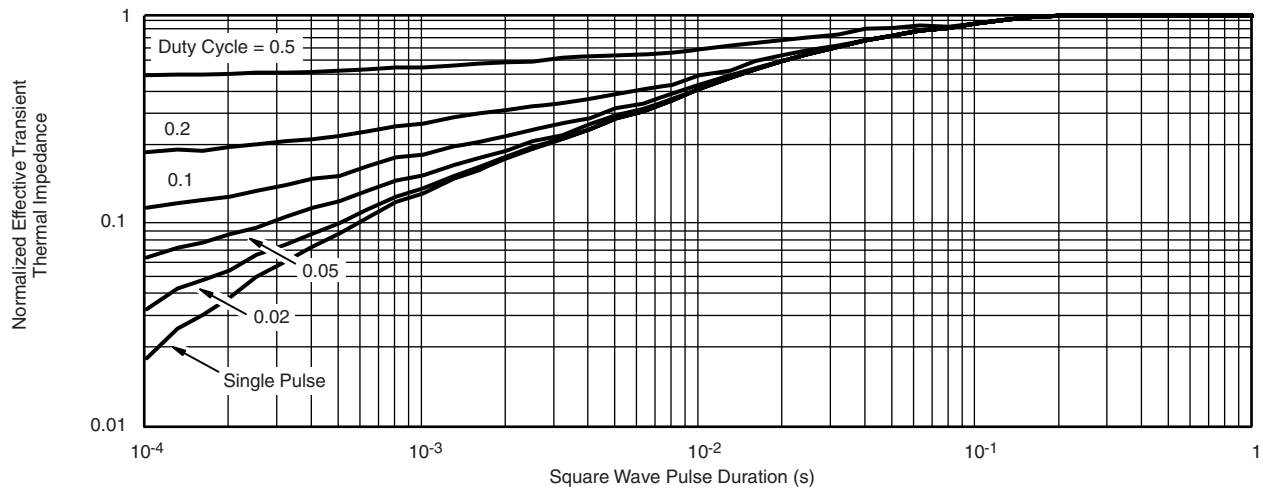


Single Pulse Avalanche Current Capability vs. Time



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area

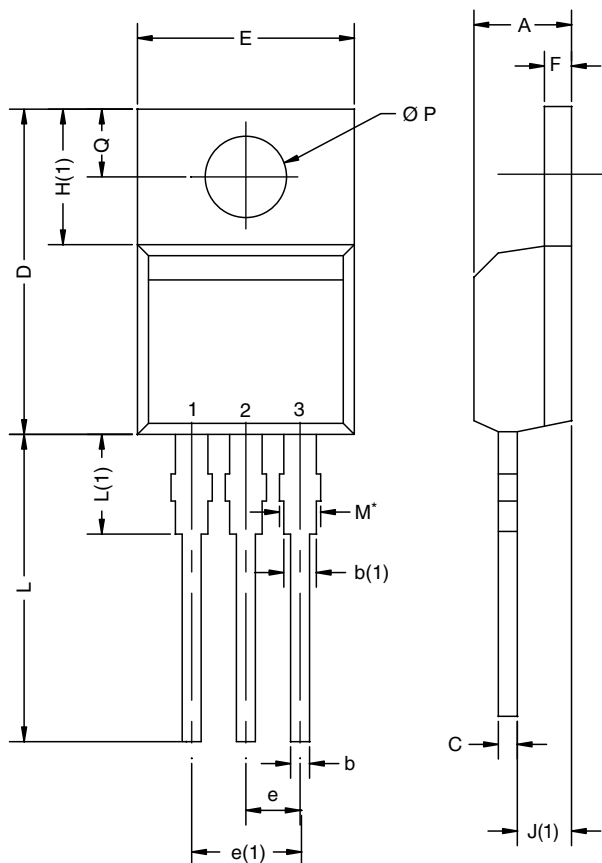


Normalized Thermal Transient Impedance, Junction-to-Case

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## TO-220AB

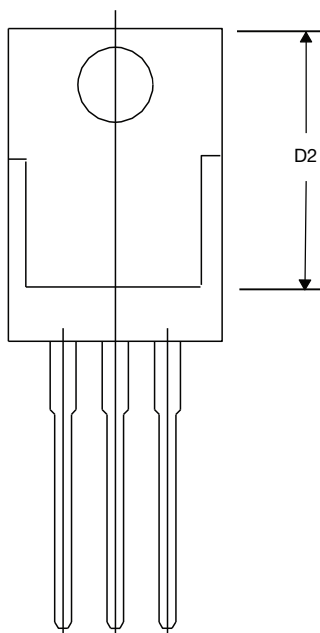


| DIM. | MILLIMETERS |       | INCHES |       |
|------|-------------|-------|--------|-------|
|      | MIN.        | MAX.  | MIN.   | MAX.  |
| A    | 4.25        | 4.65  | 0.167  | 0.183 |
| b    | 0.69        | 1.01  | 0.027  | 0.040 |
| b(1) | 1.20        | 1.73  | 0.047  | 0.068 |
| c    | 0.36        | 0.61  | 0.014  | 0.024 |
| D    | 14.85       | 15.49 | 0.585  | 0.610 |
| D2   | 12.19       | 12.70 | 0.480  | 0.500 |
| E    | 10.04       | 10.51 | 0.395  | 0.414 |
| e    | 2.41        | 2.67  | 0.095  | 0.105 |
| e(1) | 4.88        | 5.28  | 0.192  | 0.208 |
| F    | 1.14        | 1.40  | 0.045  | 0.055 |
| H(1) | 6.09        | 6.48  | 0.240  | 0.255 |
| J(1) | 2.41        | 2.92  | 0.095  | 0.115 |
| L    | 13.35       | 14.02 | 0.526  | 0.552 |
| L(1) | 3.32        | 3.82  | 0.131  | 0.150 |
| Ø P  | 3.54        | 3.94  | 0.139  | 0.155 |
| Q    | 2.60        | 3.00  | 0.102  | 0.118 |

ECN: T14-0413-Rev. P, 16-Jun-14  
DWG: 5471

### Note

\* M = 1.32 mm to 1.62 mm (dimension including protrusion)  
Heatsink hole for HVM





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